

Application Data Sheet

Application Information

Application Type:: Regular
Subject Matter:: Utility
Suggested Classification::
Suggested Group Art Unit::
CD-ROM or CD-R?:: None
Number of CD disks::
Number of Copies of CDs::
Sequence Submission?:: None
Computer Readable Form (CRF):: No
Number of copies of CRF:: 0
Title:: SEMICONDUCTOR DEVICE CAPABLE OF
PREVENTING SOLDER BALLS FROM
BEING REMOVED IN REINFORCING
PAD
Attorney Docket Number:: 8037-1001
Request for Early
Publication?:: No
Request for Non-Publication?:: No
Suggested Drawing Figure::
Total Drawing Sheets:: 5
Small Entity?:: No
Latin Name::
Variety Denomination Name::
Petition Included?:: No
Petition Type::
Licensed US Gov't Agency::
Contract or Grant Numbers::
Secrecy Order in Parent No
Appl.?::

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: JAPAN
Status:: Full Capacity
Given Name:: KIMIO
Middle Name::
Family Name:: TSUNEMASU
City of Residence:: TOKYO
State or Province of Residence::
Country of Residence:: JAPAN
Street of Mailing Address:: 7-1, SHIBA 5-CHOME
City of Mailing Address:: TOKYO
State or Province of Mailing Address:: MINATO-KU
Country of Mailing Address:: JAPAN
Postal or Zip Code of Mailing Address::

Correspondence Information

Correspondence Customer Number:: 000466

Representative Information

Representative Customer Number::	000466
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Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::

Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
JAPAN	2001-034793	2/13/01	Yes

Assignment Information

Assignee Name:: NEC CORPORATION
Street of Mailing 7-1, SHIBA 5-CHOME
Address::
City of Mailing Address:: TOKYO
State or Province of Mailing Address:: MINATO-KU
Country of Mailing Address:: JAPAN
Postal or Zip Code of Mailing Address::